

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
Symwave, Inc.		08/09/2010	CORPORATION: DELAWARE
RECEIVING PARTY DATA			
Name:	Standard Microsystems Corporation		
Street Address:	80 Arkay Drive		
City:	Hauppauge		
State/Country:	NEW YORK		
Postal Code:	11788		
Entity Type:	CORPORATION: DELAWARE		
PROPERTY NUMBERS Total: 1			
Property Type	Number	Word Mark	
Serial Number:	78517236	SYMWAVE	
CORRESPONDENCE DATA			
Fax Number:	(212)225-3999		
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>			
Email:	atalsma@cgsh.com		
Correspondent Name:	Cleary Gottlieb Steen & Hamilton LLP		
Address Line 1:	1 Liberty Plaza		
Address Line 4:	New York, NEW YORK 10006		
NAME OF SUBMITTER:	Alexander Talsma		
Signature:	/AJT/		
Date:	08/17/2010		

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Total Attachments: 5
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TRADEMARK SECURITY AGREEMENT
(SHORT-FORM)

TRADEMARK SECURITY AGREEMENT, dated as of August 9, 2010 (this "Agreement"), among Standard Microsystems Corporation, a Delaware Corporation (the "Secured Party") and Symwave, Inc., a Delaware Corporation (the "Debtor").

Reference is made to the Indemnity and Security Agreement, dated as of July 28, 2010 (as amended, supplemented or otherwise modified from time to time, the "Security Agreement") between the Secured Party and the Debtor. The agreement between the Debtor and the Secured Party in respect of amounts borrowed by the Debtor and lent by the Secured Party are set forth in a promissory note dated as of July 28, 2010 (the "Note") between the Secured Party and the Debtor. The Secured Party has also provided a guarantee to Semiconductor Manufacturing International Corporation ("SMIC") of certain Purchase Orders provided by SMIC to the Debtor ("Guarantee"). In order to secure the payment and performance of the obligations of the Debtor to the Secured Party under the Note and under the Security Agreement, certain obligations of the Debtor relating to the Guarantee, and additional obligations of the Debtor to the Secured Party, from time to time, as provided in the Security Agreement and in Schedule A attached thereto, the Debtor has agreed to grant a security interest to the Secured Party as provided for in the Security Agreement and herein. Accordingly, the parties hereto agree as follows:

Section 1. Terms. Capitalized terms used in this Agreement and not otherwise defined herein have the meanings specified in the Security Agreement.

Section 2. Grant of Security Interest. To secure the Debtor's full and timely performance of all of the Debtor's Obligations to the Secured Party, the Debtor, pursuant to and in accordance with the Security Agreement and the Note, did and hereby does grant to the Secured Party a continuing security interest in, all right, title and interest in or to any and all of the following assets and properties now owned or hereafter acquired by the Debtor or in which the Debtor now has or at any time in the future may acquire any right, title or interest (collectively, the "Trademark Collateral"):

- (a) all trademarks, service marks, trade names, corporate names, trade dress, logos, designs, fictitious business names, other source or business identifiers, now existing or hereafter adopted or acquired, all registrations and recordings thereof, and all registration and recording applications filed in connection therewith, including registrations and registration applications in the USPTO or any similar offices in any State of the United States or any other country or any political subdivision thereof, and all extensions or renewals thereof, as well as any unregistered trademarks and service marks used by the Debtor, (b) all goodwill connected with the use of and symbolized thereby and (c) all proceeds of any and all of the foregoing.

Section 3. Termination. This Agreement is made to secure the satisfactory performance and payment of the Obligations. This Agreement and the security interest granted hereby shall terminate with respect to all of Debtor's Obligations and any lien arising therefrom shall be automatically released upon termination of the Security Agreement or release of all of the Debtor's obligations thereunder. The Secured Party shall, in connection with any termination or release herein or under the Security Agreement, at the request and expense of the Debtor, execute and deliver to the Debtor the proper instruments in writing releasing the security interest in the Trademark Collateral acquired under this Agreement. Additionally, upon such satisfactory performance or payment, the Secured Party shall

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reasonably cooperate with any efforts made by the Debtor to make of record or otherwise confirm such satisfaction including, but not limited to, the release and/or termination of this Agreement and any security interest in, to or under the Trademark Collateral.

Section 4. Supplement to the Security Agreement. The security interests granted to the Secured Party herein are granted in furtherance, and not in limitation of, the security interests granted to the Secured Party pursuant to the Security Agreement. The Debtor hereby acknowledges and affirms that the rights and remedies of the Secured Party with respect to the Trademark Collateral are more fully set forth in the Security Agreement, the terms and provisions of which are hereby incorporated herein by reference as if fully set forth herein. In the event of any conflict between the terms of this Agreement and the Security Agreement, the terms of the Security Agreement shall govern.

Section 5. Representations and Warranties. The Debtor represents and warrants that a true and correct list of all of the existing material Trademark Collateral consisting of U.S. Trademark registrations or applications owned by the Debtor, in whole or in part, is set forth in Schedule I.

Section 6. Miscellaneous. The provisions of Section 13 of the Security Agreement are hereby incorporated by reference.

[Signatures on following page]

y. c.

IN WITNESS WHEREOF, the parties hereto have duly executed this Agreement as of the day and year first above written.

DEBTOR:

SYMWAVE, INC.

By: _____ *Y. Cohen*

Name: Yossi Cohen

Title: President and Chief Executive Officer

Address: 28202 Cabot Road, Suite 625
Laguna Niguel, CA 92677

Facsimile Number: (949) 543-4401

SECURED PARTY:

STANDARD MICROSYSTEMS CORPORATION

By: _____ *Walter Siegel*

Name: Walter Siegel

Title: Senior Vice President and General Counsel

Address: 80 Arkay Drive
Hauppauge, NY 11788

Facsimile Number: (631) 434-1438

[Signature page to the Short Form Trademark
Security Agreement]

Y. C.

Schedule I

Short Particulars of U.S. Trademark Collateral

[Particulars on following page]

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Title	Attorney	Filing Date	USPTO number	Issue Date	Registration number
Symwave	Steins	5/5/2009	77/729,574	6/1/2010	3,795,512
BioPrint	Steins	11/15/2004	78/517,257	3/21/2006	3,072,299
FirePhy	Steins	11/15/2004	78/517,248	1/24/2006	3,049,830
Capture, Connect, Compute	Steins	5/17/2005	78/631,853	12/5/2006	3,181,902
The Future of Connectivity	Steins	5/5/2009	77/729,595	6/22/2010	3,805,596
SymStudio	Steins	7/27/2009			
Symwave	Steins	11/15/2004	78/517,236	1/24/2006	3,049,829